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L Number	Hits	Search Text	DB	Time stamp
1	2	(wood wooden cellulosic fiber\$1board	USPAT;	2003/07/15 10:42
[		chip\$1board partcile\$1board hard\$1board	EPO; JPO;	
		flake\$1board strand\$1board wafer\$1board)	DERWENT	
	0	and (pre\$1paint with seal\$3)		
2	0	(wood wooden cellulosic fiber\$1board	USOCR	2003/07/15 09:44
		chip\$lboard partcile\$lboard hard\$lboard		
ŀ		flake\$1board strand\$1board wafer\$1board)		
3	0	and (pre\$1paint with seal\$3) (wood wooden cellulosic fiberboard	HOOOD	2002/07/15 00:46
	U	fiber-board "fiber board" chipboard	USOCR	2003/07/15 09:46
		chip-board "chip board" particleboard		
		particle-board "particle board" hardboard		
		hard-board "hard board" flakeboard		
		flake-board "flake board" strandboard		
		strand-board "strand board" waferboard		
		wafer-board "wafer board") and ((prepaint		
		pre-paint "pre paint") with (seal sealed		
		sealer sealant sealing))		
4	70	,	USOCR	2003/07/15 10:02
		fiber-board "fiber board" chipboard		
		chip-board "chip board" particleboard		
		particle-board "particle board" hardboard		
		hard-board "hard board" flakeboard		
		flake-board "flake board" strandboard		
		strand-board "strand board" waferboard		
		<pre>wafer-board "wafer board") and ("press coat" "press coated" "press coating")</pre>		
5	1	("5059264").PN.	USPAT	2003/07/15 10:20
6	16		USPAT	2003/07/15 10:20
8	3		USPAT	2003/07/15 10:03
9	_	5059264.URPN.	USPAT	2003/07/15 10:04
10	1	("5741823").PN.	USPAT	2003/07/15 10:41
11	31	("3098785"   "3607341"   "3790421"	USPAT	2003/07/15 10:20
ľ		"3804700"   "3901240"   "3919451"		
		"3933691"   "3957940"   "3961118"		
		"4061822"   "4238438"   "4265965"		
i		"4289823"   "4325856"   "4376142"		
		"4384096"   "4385152"   "4403003"		
		"4510268"   "4517228"   "4654397"		
		"4692473"   "4734231"   "4814373"   "4966170"   "5059364"   "5063646"		
		"4966170"   "5059264"   "5063646"   "5085891"   "5109030"   "5360826"		
		"5436069").PN.		
12	ol	SHEETS-Harold[in]	USPAT;	2003/07/15 10:42
**	ĭ	SHEDIO Halola(III)	EPO; JPO;	2003/07/13 10.42
			DERWENT	
13	1	SHEETS-Harold-J[in]	USPAT;	2003/07/15 10:42
	_	• •	EPO; JPO;	
1 1	ļ		DERWENT	
14	42	(wood wooden cellulosic fiber\$1board	USPAT;	2003/07/15 10:43
		chip\$1board partcile\$1board hard\$1board	EPO; JPO;	
[		flake\$1board strand\$1board wafer\$1board)	DERWENT	
		and GLIDDEN[as]		
15	13	(wood wooden cellulosic fiber\$1board	USPAT;	2003/07/15 10:43
		chip\$lboard partcile\$lboard hard\$lboard	EPO; JPO;	
		flake\$1board strand\$1board wafer\$1board)	DERWENT	
16	5	<pre>and GLIDDEN(as) and seal\$4 (wood wooden cellulosic fiber\$1board</pre>	HCDAM.	2002/07/15 10 47
- "	اد	chip\$lboard partcile\$lboard hard\$lboard	USPAT; EPO; JPO;	2003/07/15 10:47
		flake\$1board strand\$1board wafer\$1board)	DERWENT	
		and GLIDDEN(as) and seal\$4 and (primer	PERMENT	
		primed multi\$llayer)		
17	3	((wood wooden cellulosic fiber\$1board	USPAT;	2003/07/15 10:45
	-	chip\$1board partcile\$1board hard\$1board	EPO; JPO;	
		flake\$1board strand\$1board wafer\$1board)	DERWENT	
		and GLIDDEN[as] and seal\$4 and (primer		
		<pre>primed multi\$1layer)) not 5059264[pn]</pre>		
18	1	5059264 [pn]	USPAT	2003/07/15 10:45
19		("3983307"   "4017434"   "4505986").PN.	USPAT	2003/07/15 10:45
20	16	5059264.URPN.	USPAT	2003/07/15 10:45

			,	r
21	35	<pre>(wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and HSU[in] and (primer primed</pre>	USPAT; EPO; JPO; DERWENT	2003/07/15 11:01
		multi\$1layer)		
22	283		USPAT; EPO; JPO; DERWENT	2003/07/15 11:02
23	135	<pre>(wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (multi\$1layer same (ultra\$1violet "UV")) and (primed primer sealed sealing</pre>	USPAT; EPO; JPO; DERWENT	2003/07/15 11:03
24	· 172	chip\$lboard partcile\$lboard hard\$lboard flake\$lboard strand\$lboard wafer\$lboard) and (multi\$llayer same ((ultra\$lviolet "UV") with cure cured curing)) and (primed	USPAT; EPO; JPO; DERWENT	2003/07/15 11:03
	112	chip\$lboard partcile\$lboard hard\$lboard flake\$lboard strand\$lboard wafer\$lboard) and (multi\$llayer same ((ultra\$lviolet "UV") with cure cured curing)) and (sealed	USPAT; EPO; JPO; DERWENT	2003/07/15 11:13
26	6	sealing sealant) (("4072770") or ("4082882") or ("5212271") or ("5453451") or ("5584496") or ("5740941")).PN.	USPAT	2003/07/15 11:11
27	1	("5453451").PN.	USPAT	2003/07/15 11:11
28	130	<pre>(wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (top\$1coat\$3 same ((ultra\$1violet "UV") with cure cured curing)) and (sealed sealing sealant)</pre>	USPAT; EPO; JPO; DERWENT	2003/07/15 11:14
29	125	(wood wooden cellulosic fiber\$lboard chip\$lboard partcile\$lboard hard\$lboard flake\$lboard strand\$lboard wafer\$lboard) and (top\$lcoat\$3 same ((ultra\$lviolet "UV") with cure cured curing)) and (sealed sealing sealant)	USPAT	2003/07/15 11:46
30	126	(wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (top\$1coat\$3 same ((ultra\$1violet "UV") with cure cured curing)) and (primed primer priming sealed sealing sealant)	USPAT ·	2003/07/15 11:50
31	52	(wooden fiber\$lboard chip\$lboard partcile\$lboard hard\$lboard flake\$lboard strand\$lboard wafer\$lboard) and (top\$lcoat\$3 same ((ultra\$lviolet "UV") with cure cured curing)) and (primed	USPAT	2003/07/15 12:12
32	690	<pre>primer priming sealed sealing sealant) (wooden fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and ((coating near3 line) (production near3 line))</pre>	USPAT	2003/07/15 12:16
33	14	· · · · ·	USPAT	2003/07/15 12:13
34	140	(wooden fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (coating near3 line)	USPAT	2003/07/15 12:16

35	13		USPAT	2003/07/15 12:16
		partcile\$1board hard\$1board flake\$1board		
		strand\$1board wafer\$1board) and (coating		
	_	near3 line)) and primer and top\$1coat\$3		0000/07/15 10 16
36	0	` ` ` · •	USPAT	2003/07/15 12:16
		partcile\$1board hard\$1board flake\$1board		
		strand\$1board wafer\$1board) and (coating		
		near3 line)) and primer and top\$1coat\$3)		
		not (((wooden fiber\$1board chip\$1board		
		partcile\$1board hard\$1board flake\$1board		
		strand\$1board wafer\$1board) and ((coating		
		near3 line) (production near3 line))) and		
	107	primer and top\$1coat\$3)	110000	2003/07/15 12:17
37	127		USPAT	2003/07/15 12:17
		partcile\$1board hard\$1board flake\$1board		
		strand\$1board wafer\$1board) and (coating		
		near3 line)) not (((wooden fiber\$lboard		
		chip\$1board partcile\$1board hard\$1board		
		flake\$1board strand\$1board wafer\$1board)		
		and ((coating near3 line) (production		
	4045	near3 line))) and primer and top\$1coat\$3) ((427/258) or (427/369) or (427/370) or	USPAT;	2003/07/14 16:01
-	4045		EPO; JPO;	2003/07/14 10:01
		(427/371) or (427/407.1) or (427/408) or	DERWENT	•
	66	(427/412.2)).CCLS. (((427/258) or (427/369) or (427/370) or	USPAT;	2003/07/14 16:01
_	00	((427/371) or (427/407.1) or (427/408) or	EPO; JPO;	2003/07/14 10:01
		(427/412.2)).CCLS.) and (press\$3 near3	DERWENT	
		(427/412.2)).CCLS.) and (pressys hears	DEKWENT	
	26	I	USPAT;	2003/07/14 16:25
_	20	(((427/238)  of  (427/363)  of  (427/370)  or  (427/371)  or  (427/407.1)  or  (427/408)  or	EPO; JPO;	2003/07/14 10:23
		(427/412.2)).CCLS.) and (press\$3 near3	DERWENT	
		bond\$3)) and (wood wooden cellulosic	DERWENT	
		fiber\$1board chip\$1board partcile\$1board)		
	9		USPAT;	2003/07/14 16:22
_	,	(427/371) or $(427/407.1)$ or $(427/408)$ or	EPO; JPO;	2003/07/11 10:22
		(427/412.2)).CCLS.) and (press\$3 near3	DERWENT	
		bond\$3)) and (wood wooden cellulosic	<i>5</i> 212	
		fiber\$1board chip\$1board partcile\$1board))		
		and (coat\$3 near3 cur\$4)		
l <u>-</u>	2	((((((427/258) or (427/369) or (427/370)	USPAT;	2003/07/14 16:03
	_	or (427/371) or (427/407.1) or (427/408)	EPO; JPO;	
		or (427/412.2)).CCLS.) and (press\$3 near3	DERWENT	
		bond\$3)) and (wood wooden cellulosic		
		fiber\$1board chip\$1board partcile\$1board))		
		and (coat\$3 near3 cur\$4)) and (("UV"		
		ultra\$1violet) near3 cur\$4)		
-	0	((((((427/258)  or  (427/369)  or  (427/370)	USPAT;	2003/07/14 16:03
1		or (427/371) or (427/407.1) or (427/408)	EPO; JPO;	
		or (427/412.2)).CCLS.) and (press\$3 near3	DERWENT	
-		bond\$3)) and (wood wooden cellulosic		
		<pre>fiber\$1board chip\$1board partcile\$1board))</pre>		
1		and (coat\$3 near3 cur\$4)) and (("UV"		
		ultra\$1violet) near3 cur\$4)) and (primer		
		primed priming)		
-	2	15	USPAT;	2003/07/14 16:06
		or (427/371) or (427/407.1) or (427/408)	EPO; JPO;	
		or (427/412.2)).CCLS.) and (press\$3 near3	DERWENT	
		bond\$3)) and (wood wooden cellulosic		
		<pre>fiber\$1board chip\$1board partcile\$1board))</pre>		
		and (coat\$3 near3 cur\$4)) and (("UV"		
		ultra\$1violet) near3 cur\$4)) and (prime		
		primer primed priming)		
-	812	"press coating"	USPAT;	2003/07/14 16:07
			EPO; JPO;	
			DERWENT	
-	13	(((427/258) or (427/369) or (427/370) or	USPAT;	2003/07/14 16:07
		(427/371) or (427/407.1) or (427/408) or	EPO; JPO;	
		(427/412.2)).CCLS.) and "press coating"	DERWENT	

_	7	((((((427/258) or (427/369) or (427/370)	USPAT;	2003/07/14 16:22
		or (427/371) or (427/407.1) or (427/408)	EPO; JPO;	1
		or (427/412.2)).CCLS.) and (press\$3 near3	DERWENT	
		bond\$3)) and (wood wooden cellulosic		1
		<pre>fiber\$1board chip\$1board partcile\$1board))</pre>		
		and (coat\$3 near3 cur\$4)) not		
		(((((((427/258) or (427/369) or (427/370)		
		or (427/371) or (427/407.1) or (427/408)		
		or (427/412.2)).CCLS.) and (press\$3 near3		
		bond\$3)) and (wood wooden cellulosic		
		fiber\$1board chip\$1board partcile\$1board))		
		and (coat\$3 near3 cur\$4)) and (("UV"		
		ultra\$1violet) near3 cur\$4))		}
-	1122	,,,	USPAT;	2003/07/14 16:28
		chip\$1board partcile\$1board hard\$1board	EPO; JPO;	
		flake\$1board strand\$1board wafer\$1board)	DERWENT	
		with coat\$3) same ((press\$3 near3 coat\$3)		
		(heat\$3 near3 press\$3)))		
_	9	((("""" """ """ """ """ """ """ """ """	USPAT;	2003/07/14 16:37
		chip\$1board partcile\$1board hard\$1board	EPO; JPO;	
		flake\$1board strand\$1board wafer\$1board)	DERWENT	
		with coat\$3) same ((press\$3 near3 coat\$3)		
		(heat\$3 near3 press\$3))) and (top\$1coat\$3		
		same ("UV" ultra\$1violet))		/ /
-	51		USPAT;	2003/07/14 16:38
		chip\$1board partcile\$1board hard\$1board	EPO; JPO;	
		flake\$1board strand\$1board wafer\$1board)	DERWENT	
		with coat\$3) same ((press\$3 near3 coat\$3)		]
		(heat\$3 near3 press\$3)) same (seal\$4)		
-	50	1 ( ( ( ) ) )	USPAT;	2003/07/15 09:41
		chip\$1board partcile\$1board hard\$1board	EPO; JPO;	
		flake\$1board strand\$1board wafer\$1board)	DERWENT	
		with coat\$3) same ((press\$3 near3 coat\$3)		
		(heat\$3 near3 press\$3)) same (seal\$4)) not		
		((((wood wooden cellulosic fiber\$1board		
		chip\$1board partcile\$1board hard\$1board		
		flake\$1board strand\$1board wafer\$1board)		
		with coat\$3) same ((press\$3 near3 coat\$3)		
		(heat\$3 near3 press\$3))) and (top\$1coat\$3		
	I	same ("UV" ultra\$1violet)))	I	1